

Scavenger Transceiver Module STM 300 / STM 300C

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EnOcean GmbH Kolpingring 18a 82041 Oberhaching Germany Phone +49.89.67 34 689-0 Fax +49.89.67 34 689-50 info@enocean.com www.enocean.com Subject to modifications STM 300 / STM 300C User Manual V1.30 March 4, 2011 2:06 PM Page 1/40



#### **REVISION HISTORY**

The following major modifications and improvements have been made to the first version of this document:

No	Major Changes
1.01	Tape running direction added in 3.8
1.10	Application note for multiple digital inputs with WAKE functionality added.
1.20	Error corrected in 3.5.1. and 4.1: Maximum gain of external antenna at 50 Ohm output RF_50 is 0 dBi!
1.25	Charging circuit in 3.1 corrected; remarks added regarding use of IOVDD in 2.3. Parameters of A/D converter corrected and specified in more detail in 2.3.2
1.26	Optional resolution at ADIO0, ADIO1, ADIO2 corrected in 2.3. Detailed description in 2.9.1 was correct!
1.30	New improved application note in 3.1, which avoids deep discharge of the long term storage.

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Packing: Please use the recycling operators known to you.



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## **1 GENERAL DESCRIPTION**

#### **1.1** Basic functionality

The extremely power saving RF transmitter module STM 300 of EnOcean enables the realization of wireless and maintenance free sensors and actuators such as room operating panels, motion sensors or valve actuators for heating control.

Power supply is provided by an external energy harvester, e.g. a small solar cell (e.g. EnOcean ECS 3x0) or a thermal harvester. An energy storage device can be connected externally to bridge periods with no supply



from the energy harvester. A voltage limiter avoids damaging of the module when the supply from the energy harvester gets too high. The module provides a user configurable cyclic wake up. After wake up a radio telegram (input data, unique 32 bit sensor ID, checksum) will be transmitted in case of a change of any digital input value compared to the last sending or in case of a significant change of measured analogue values (different input sensitivities can be selected). In case of no relevant input change a redundant retransmission signal is sent after a user configurable number of wake-ups to announce all current values. In addition a wake up can be triggered externally.

#### **Features with built-in firmware**

- 3 A/D converter inputs
- 4 digital inputs
- Configurable wake-up and transmission cycle
- Wake-up via Wake pins
- Voltage limiter
- Threshold detector
- Application notes for calculation of energy budgets and management of external energy storages

#### **Product variants**

STM 300/300C: SMD mountable module for use with external antenna (868/315 MHz)

#### Features accessible via API

Using the Dolphin API library it is possible to write custom firmware for the module. STM 300 / STM 300C is in-system programmable. The API provides:

- Integrated 16 MHz 8051 CPU with 32 KB FLASH and 2 kB SRAM
- Receiver functionality
- Various power down and sleep modes down to typ. 0.2 μA current consumption
- Up to 16 configurable I/Os
- 10 bit ADC, 8 bit DAC



#### 1.2 Technical data

Antenna	External whip or 50 $\Omega$ antenna mountable		
Frequency	315.0 MHz (STM 300C)/868.3 MHz (STM 300)		
Radio Standard	EnOcean 868 MHz/315 MHz		
Data rate/Modulation type	125 kbps/ASK		
Receiver Sensitivity (at 25 °C)	receiver available only via API, typ96 dBm <sup>1</sup> (868MHz) typ98 dBm <sup>1</sup> (315MHz)		
Conducted Output Power	typ. 5 dBm		
Power Supply	2.1 V-4.5 V, 2.6 V needed for start-up		
Current Consumption	Deep Sleep mode : typ. 0.2 µA Transmit mode: typ. 24 mA, max. 33 mA		
	Receive mode (available via API only): typ. 33 mA, max. 43 mA		
Input Channels	4x digital input, 2x WAKE input , 3x analog input Resolution: 3x 8 bit or 1x 10 bit, 1x 8 bit, 1x 6 bit		
Radio Regulations	R&TTE EN 300 220 (STM 300) FCC CFR-47 Part 15 (STM 300C)		

#### **1.3** Physical dimensions

PCB dimensions	STM 300/STM 300C: 22x19x3.1 mm
Weight	1.9 g



STM 300 / STM 300C (pads on bottom side of PCB!)

 $<sup>^{\</sup>rm 1}$  @ 0.1% telegram error rate (based on 3 transmitted sub-telegrams)



## **1.4** Environmental conditions

Operating temperature	-25 °C +85 °C
Storage temperature	-40 °C +85 °C
Storage temperature in tape & reel package	-20 °C +50 °C
Humidity	0% 93% r.h., non-condensing

## 1.5 Ordering Information

Туре	Ordering Code	Frequency
STM 300	S3001-D300	868.3 MHz
STM 300C	S3031-D300	315.0 MHz

Suited solar cells (for technical details please refer to the ECS3x0 data sheet):

Туре	Ordering Code	Size
ECS 300	S3005-D305	35.0×12.8×1.1 mm
ECS 310	S3005-D310	50.0×20.0×1.1 mm



## 2 FUNCTIONAL DESCRIPTION

## 2.1 Simplified firmware flow chart and block diagram





## 2.2 Hardware pin out



The figure above shows the pin out of the STM 300 hardware. The pins are named according to the naming of the EO3000I chip to simplify usage of the DOLPHIN API.

The table in section 2.3 shows the translation of hardware pins to a naming that fits the functionality of the built-in firmware. When writing own firmware based on the DOLPHIN API please refer to the Dolphin Core Description and use this manual only for information regarding the module hardware, such as pin out, layout recommendations, charging circuitry, antenna options, and approvals.



## 2.3 Pin description and operational characteristics

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STM 300 Hardware Symbol	STM 300 Firmware Symbol	Function	Characteristics
GND	GND	Ground connection	Must be connected to GND
VDD	VDD	Supply voltage	2.1 V – 4.5 V; Start-up voltage: 2.6 V Maximum ripple: see 2.6
RVDD	V_OUT	RF supply voltage regulator output	1.8 V. Output current: max. 10 mA. See 3.4! Supply for external circuitry, available while not in deep sleep mode.
DVDD	DVDD	Digital supply volt- age regulator out- put	1.8 V. Output current: max. 5 mA Supply for external circuitry, available while not in deep sleep mode.
UVDD	UVDD	Ultra low power supply voltage regulator output	Not for supply of external circuitry! For use with WAKE pins, see section 3.3. Max. 1 $\mu$ A output current!
VDDLIM	VDDLIM	Supply voltage limiter input	Limitation voltage: 4.5 V Maximum shunting current: 50 mA
IOVDD	IOVDD	GPIO supply volt- age	Must be connected to desired interface supply voltage as specified in 2.5, e.g. to DVDD. See also 2.3.1
RESET	RESET	Reset input Programming I/F	Active high reset (1.8 V) Connect external 10 kΩ pull-down.
PROG_EN	PROG_EN	Programming I/F	HIGH: programming mode active LOW: operating mode Digital input, connect external 10 k $\Omega$ pull-down.
ADIO0	AD_0	Analog input	Input read ~2 ms after wake-up. Resolution 8 bit (default) or 10 bit. See also 2.3.2.
ADIO1	AD_1	Analog input	Input read ~2 ms after wake-up. Resolution 8 bit (default) or 6 bit. See also 2.3.2.
ADIO2	AD_2	Analog input	Input read ~2 ms after wake-up. Resolution 8 bit. See also 2.3.2.
ADIO3	DI_0	Digital input	Input read ~2 ms after wake-up. See also 2.3.2.
ADIO4	DI_1	Digital input	Input read ~2 ms after wake-up. See also 2.3.2.
ADIO5	DI_2	Digital input	Input read ~2 ms after wake-up. See also 2.3.2.
ADIO6	DI_3	Digital input	Input read ~2 ms after wake-up. See also 2.3.2.



	1		
ADIO7	LED	Transmission indicator LED	Max. output current: 2 mA @ IOVDD=3.3 V 0.65 mA @ IOVDD=1.8 V
		Programming I/F	
SCSEDIO0	CW_1	Encoding input for wake-up cycle	Leave open or connect to GND
		Programming I/F	
SCLKDIO1	CW_0	Encoding input for wake-up cycle	Leave open or connect to GND
		Programming I/F	
WSDADIO2	CP_1	Encoding input for retransmission	Leave open or connect to GND
		Programming I/F	
RSDADIO3	CP_0	Encoding input for retransmission	Leave open or connect to GND
		Programming I/F	
WXIDIO	SCO	Sensor control	Digital output, max. current 15 µA HIGH ~x ms before analog inputs are read (x=0508 ms; default 2 ms.) LOW at wake-up and after reading of analog inputs Polarity can be inverted, delay time can be programmed, see 2.8.2.
WXODIO	ССО	Charge control	Max output current 15 µA See 2.7 for description of behaviour.
WAKE0	WAKE0	Wake input	Change of logic state leads to wake-up and transmission of a telegram. See also 3.3.
WAKE1	LRN	LRN input	Change of logic state to LOW leads to wake-up and transmission of teach-in tele- gram if a manufacturer code is pro- grammed. See also 2.9.2 and 3.3.
RF_WHIP	RF_WHIP	RF output	Output for whip antenna
RF_50	RF_50	RF output	50 Ohm output for external antenna

#### 2.3.1 GPIO supply voltage

For digital communication with other circuitry (peripherals) the digital I/O configured pins of the mixed signal sensor interface (ADIO0 to ADIO7) and the pins of the programming interface (SCSEDIO0, SCLKDIO1, WSDADIO2, RSDADIO3) may be operated from supply voltages different from DVDD. Therefore an interface supply voltage pin IOVDD is available which can be connected either to DVDD or to an external supply within the tolerated voltage range of IOVDD. Please note that the wristwatch XTAL I/Os WXIDIO and WXODIO are always supplied from UVDD.





If DVDD=0 V (e.g. in any sleep mode) and IOVDD is supplied, there may be unpredictable and varying current from IOVDD caused by internal floating nodes. It must be taken care that the current into IOVDD does not exceed 10 mA while DVDD=0 V.

If DVDD=0 V and IOVDD is not supplied, do not apply voltage to any above mentioned pin. This may lead to unpredictable malfunction of the device.



IOVDD voltage must not exceed VDD voltage! A malfunction of the module may be caused by such inverse supply!

For I/O pins configured as analog pins the IOVDD voltage level is not relevant! However it is important to connect IOVDD to a supply voltage as specified in 2.5.



#### 2.3.2 Analog and digital inputs

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Parameter	<b>Conditions / Notes</b>	Min	Тур	Max	Units
Analog Input Mode		-			
Measurement range	Single ended Internal reference RVDD/2	0.067		RVDD- 0.12	V
Input coupling			DC		
Measurement bandwidth <sup>2</sup>			62.5		kHz
Input impedance	Single ended against GND @ 1 kHz	10			MΩ
Input capacitance	Single ended against GND @ 1 kHz			10	pF
Effective measurement resolution			10		Bit
10bit measurement					
Offset error			23	36	LSB
Gain error			32	62	LSB
TAU	Code <=200		+3 -14	+6 -23	LSB
INL	Code >200		+3 -4	+6 -10	LSB
DNL				<±0.5	LSB
8bit measurement					
Offset error			6	9	LSB
Gain error			8	16	LSB
INL	Code <=50		+1 -4	+2 -6	LSB
	Code >50		+1 -1	+2 -3	LSB
DNL				<±0.125	LSB

**Offset Error:** Describes the offset between the minimal possible code and code<sub>ADC</sub> over 0x00.

**Gain Error:** Describes the offset between maximum possible code and full scale (e.g. 0x3FF for 10bit measurements).

**Integral Non-Linearity (INL):** Describes the difference between the ideal characteristics and the real characteristics. Only values between minimum and maximum possible code are considered (excluding offset error and gain error). **Differential Non-Linearity (DNL):** Measures the maximum deviation from

the ideal step size of 1 LSB (least significant bit).

**Effective resolution:** Results from the signal-noise ratio of the ADC and is given in Bit. The number describes how many bits can be measured stable. The criterion selected here is that the noise of DNL is  $<\pm 0.5$  LSB.

**Measurement Bandwidth:** The measurement bandwitch is internally limited by filters. A quasi static signal must be applied as long as the filter needs to settle. SettlingTime= 1/(MeasurementBandwidth)\*In(2^resolution[Bit])



 $^2$  3dB input bandwidth, resulting in 111µs settling time to achieve a deviation of an input signal <1LSB (<0.098% @ 10bit resolution).



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Parameter	<b>Conditions / Notes</b>	Min	Тур	Max	Units
Digital Input Mode					
		2/3			V
Input HIGH voltage		IOVDD			
Input I OW voltage				1/3	V
Input LOW voltage				IOVDD	
Pull up resistor	@IOVDD=1.7 1.9 V	90	132	200	kΩ
	@IOVDD=3.0 3.6 V	38	54	85	kΩ

## 2.4 Absolute maximum ratings (non operating)

Symbol	Parameter	Min	Max	Units
VDD VDDLIM	Supply voltage at VDD and VDDLIM	-0.5	5.5	V
IOVDD	GPIO supply voltage	-0.5	3.6	V
GND	Ground connection	0	0	V
VINA	Voltage at every analog input pin	-0.5	2	V
VIND1	Voltage at RESET, WAKE0/1, and every digital input pin except WXIDIO/WXODIO	-0.5	3.6	V
VIND2	Voltage at WXIDIO / WXODIO input pin	-0.5	2	V

## 2.5 Maximum ratings (operating)

Symbol	Parameter	Min	Max	Units
VDD VDDLIM	Supply voltage at VDD and VDDLIM	VOFF	4.5	V
IOVDD	GPIO supply voltage (see also 2.3.1)	1.7	MIN (3.6; VDD)	V
GND	Ground connection	0	0	V
VINA	Voltage at every analog input pin	0	2.0	V
VIND1	Voltage at RESET, WAKE0/1, and every digital input pin except WXIDIO / WXODIO	0	3.6	V
VIND2	Voltage at WXIDIO / WXODIO input pin	0	2.0	V

## 2.6 Power management and voltage regulators

Symbol	Parameter	<b>Conditions / Notes</b>	Min	Тур	Max	Units
Voltage	Regulators					
VDDR	Ripple on VDD, where				50	$mV_{pp}$
VDDR	Min(VDD) > VON					
UVDD	Ultra Low Power supply			1.8		V
RVDD	RF supply		1.7	1.8	1.9	V
DVDD	Digital supply		1.7	1.8	1.9	V

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Voltage	Limiter					
VLIM	Limitation voltage			4.5		V
ILIM	Shunting current				50	mA
Thresho	ld Detector					
VON	Turn on threshold		2.3	2.45	2.6	V
VOFF	Turn off threshold	Automatic shutdown if VDD drops below VOFF	1.85	1.9	2.1	V

#### **Voltage Limiter**

STM 300 provides a voltage limiter which limits the supply voltage VDD of STM 300 to a value VDDLIM which is slightly below the maximum VDD ratings by shunting of sufficient current.

#### **Threshold detector**

STM 300 provides an ultra low power ON/OFF threshold detector. If VDD > VON, it turns on the ultra low power regulator (UVDD), the watchdog timer and the WAKE# pins circuitry. If VDD  $\leq$  VOFF it initiates the automatic shut down of STM 300.

## 2.7 Charge control output (CCO)

After start-up STM 300 provides the output signal of the threshold detector at CCO. CCO is supplied by UVDD. The output value remains stable also when STM 300 is in deep sleep mode.

#### **Behaviour of CCO**

- At power up: TRISTATE until VDD>VON then HIGH
- if VDD>VON then HIGH
- if VDD<VON then LOW
- if VDD< VOFF then LOW or TRISTATE



For definition of VON and VOFF please refer to 2.6.

### 2.8 Configuration

#### 2.8.1 Configuration via pins

The encoding input pins have to be left open or connected to GND in correspondence with the following connection schemes. These settings are checked at every wake-up.

#### Wake-up cycle time

CW_0	CW_1	Wake-up cycle time
NC	NC	1 s ±20%
GND	NC	10 s ±20%
NC	GND	100 s ±20%
GND	GND	No cyclic wake-up

#### **Redundant retransmission**

Via CP\_0 and CP\_1 an internal counter is set which is decreased at every wake-up signal. Once the counter reaches zero the redundant retransmission signal is sent.

CP_0	CP_1	Number of wake-ups that trigger a redundant retransmission
NC	NC	Every timer wake-up signal
GND	NC	Every 7 <sup>th</sup> - 14 <sup>th</sup> timer wake-up signal, affected at random
NC	GND	Every 70 <sup>th</sup> - 140 <sup>th</sup> timer wake-up signal, affected at random
GND	GND	No redundant retransmission



A radio telegram is always transmitted after wake-up via WAKE pins! After transmission the counter is reset to a random value within the specified interval.



According to FCC 15.231a) a redundant retransmission at every timer wake-up to determine the system integrity is only allowed in safety and security applications! In this case the total transmission time must not exceed two seconds per hour, which means that a combination with a 1 s wake-up cycle time is not allowed!

If applied in other (non-safety, non-security) applications a minimum of 10 s between periodic transmissions is required. In addition the device has to comply with the lower field strength limits of 15.231e). The limited modular approval of STM 300C is not valid in this case.



#### 2.8.2 Configuration via programming interface

Via the programming interface the configuration area can be modified. This provides a lot more configuration options. Values set via programming interface override hardware settings! These settings are read after RESET or power-on reset only and not at every wakeup of the module!

Parameter	Configuration via pins	Configuration via programming interface				
Wake up cycle	See section 2.8.1	Value can be set from 1 s to 65534 s				
Redundant Retransmission cycle	See section 2.8.1	MinMax values for random interval If Min=Max -> random switched off				
Threshold values for analog inputs	No	The default values are: 5 LSB at AD_1 input, 6 LSB at AD_0 and 14 LSB at AD_2. The threshold value can be set between 0 and full scale for every input individually.				
Resolution of the analog inputs	No	Default: AD_0: 8 bit, AD_1: 8 bit, AD_2: 8 bit Option: AD_0: 10 bit, AD_1: 6 bit, AD_2: 8 bit				
Input mask	No	A digital input mask for ignoring changes on digital input pins. At default all input bits are checked.				
Delay time between SCO on and sampling moment	No	Value can be set from 0 ms to 508 ms in steps of 2 ms. Default delay time is 2 ms.				
Source of AD_2	No	Select if AD_2 contains measurement value of external ADIO2 pin or from internal VDD/4				
Polarity of SCO signal	No	Polarity can be inversed.				
Edge of wake pin change causing a telegram trans- mission	No	Every change of a wake pin triggers a wake-up. For both wake pins it can be configured indi- vidually if a telegram shall be sent on rising, falling or both edges.				
Manufacturer ID and EEP (EnOcean Equipment Profile)	No	Information about manufacturer and type of device. This feature is needed for "automatic" interoperability of sensors and actuators or bus systems. Information how to set these parame- ters requires an agreement with EnOcean. Unique manufacturer IDs are distributed by the EnOcean Alliance.				

The interface is shown in the figure below:



#### Dolphin Studio, or EOP

EnOcean provides EOPx (EnOcean Programmer, a command line program) and Dolphin Studio (Windows application for chip configuration, programming, and testing) and the USB/SPI programmer device as part of the EDK 300 developer's kit.



## 2.9 Radio telegram

#### 2.9.1 Normal operation

Telegram content (seen at programming interface of RCM 130/TCM 3x0 or at DOLPHIN API):

ORG	= 0x07 (T	elegram type "4BS")	
	Byte13		
3x8bit	-		
	DATA_BYTE3 =	= Value of AD_2 analog ing	but
	DATA_BYTE2 =	= Value of AD_1 analog in	out
	DATA_BYTE1 =	= Value of AD_0 analog inp	out
1x8bit.	1x6it, 1x10bit mo	de:	
2/(0.5/10)	DATA_BYTE3 =		
		= Upper 2 bits of AD_0 and	value of AD_1
		= Lower 8 bits Value of AD	
	DATA_BYTE3	DATA_BYTE2	DATA_BYTE1
	AD_2	AD_1	AD_0
	7 6 5 4 3 2 1	0 5 4 3 2 1 0 9 8 7	6 5 4 3 2 1 0
DATA_ Bit 7	<b>_BYTE0</b> = Digital s	sensor inputs as follows: Bit 0	
	rved, set to 0 DI_		
ID BYT		identifier (Byte3)	
_		identifier (Byte2)	
ID_BYT			
_	TE1 = module	identifier (Byte1) identifier (Byte0)	

The voltages measured at the analog inputs can be calculated from these values as follows:

 $U=(Value of AD_x)/(2^n)x1.8 V$  n=resolution of channel in bit

#### 2.9.2 Teach-in telegram

In case a manufacturer code is programmed into the module the module transmits – instead of transmitting a normal telegram – a dedicated teach-in telegram if

- digital input DI\_3=0 at wake-up or
- wake-up via WAKE1 pin (LRN input)

With this special teach-in telegram it is possible to identify the manufacturer of a device and the function and type of a device. There is a list available from the EnOcean Alliance describing the functionalities of the respective products.

If no manufacturer code is programmed the module does not react to signal changes on WAKE1 (LRN input)!

ORG	= 0x07 (Telegra	m type "4B	5″)						
DATA_BYTE03	see below LRN Type = 1 LRN = 0 DI0DI2: curren Profile, Type, Ma RE02: set to 0		-	•		anufa	octure	r	
ID_BYTE3 ID_BYTE2 ID_BYTE1 ID_BYTE0	<ul> <li>module identif</li> <li>module identif</li> <li>module identif</li> <li>module identif</li> </ul>	ier (Byte2) ier (Byte1)							
ORG Data_By	/te3 Data_Byte	2 Data_By	te1	Data_	Byte				
Function Type 6 Bit 7 Bit	Manufacturer- ID 11 Bit	LRN Type 1Bit		RE1 1Bit		LRN 1Bit		DI1 1Bit	DI0 1Bit

## 2.10 Transmit timing

The setup of the transmission timing allows avoiding possible collisions with data packages of other EnOcean transmitters as well as disturbances from the environment. With each transmission cycle, 3 identical subtelegrams are transmitted within 40 ms. Transmission of a subtelegram lasts approximately 1.2 ms. The delay time between the three transmission bursts is affected at random.



If a new wake-up occurs before all sub-telegrams have been sent, the series of transmissions is stopped and a new series of telegrams with new valid measurement values is transmitted.



## 2.11 Energy consumption



Current Consumption of STM 300

Charge needed for one measurement and transmit cycle:  ${\sim}130~\mu C$  Charge needed for one measurement cycle without transmit:  ${\sim}30~\mu C$  (current for external sensor circuits not included)

Calculations are performed on the basis of electric charges because of the internal linear voltage regulator of the module. Energy consumption varies with voltage of the energy storage while consumption of electric charge is constant.

Wake cycle [s]	Transmit interval	Operation Time in darkness [h] when storage fully charged	Required reload time [h] at 200 lux within 24 h for continuous operation	24 h operation after 6 h illumination at x lux	Illumina- tion level in lux for continuous operation	Current in µA required for con- tinuous operation
1	1	0.5	storage too small	storage too small	5220	130.5
1	10	1.7	storage too small	storage too small	1620	40.5
1	100	2.1	storage too small	storage too small	1250	31.3
10	1	5.1	storage too small	storage too small	540	13.5
10	10	16	21	storage too small	175	4.4
10	100	20	16.8	storage too small	140	3.5
100	1	43	7.8	260	65	1.6
100	10	98	3.6	120	30	0.8
100	100	112	3	100	25	0.6

From these values the following performance parameters have been calculated:

Assumptions:

- Storage PAS614L-VL3 with 0.25 F, Umax=3.2 V, Umin=2.2 V, T=25°C
- Consumption: Transmit cycle 100 μC, measurement cycle 30 μC
- Indoor solar cell, operating values 3 V and 5 µA @ 200 lux fluorescent light (e.g. ECS 300 solar cell)
- Current proportional to illumination level (not true at very low levels!)

These values are calculated values, the accuracy is about +/-20%!



## **3** APPLICATIONS INFORMATION

### **3.1** How to connect an energy harvester and energy storage

STM 300 is designed for use with an external energy harvester and energy storage.

In order to support a fast start-up and long term operation with no energy supply available usually two different storages are used. The small storage fills quickly and allows a fast start-up. The large storage fills slowly but once it is filled up it provides a large buffer for times where no energy is available, e.g. at night in a solar powered sensor.

STM 300 provides a digital output CCO (see also 2.7) which allows controlling the charging of these two storages. At the beginning, as long as the voltage is below the VON voltage only the small storage is filled. Once the threshold is reached the CCO signal changes and the large storage is filled. The short term storage capacitor (C1) is usually in the range of 470 to 1000  $\mu$ F. For the long term storage we suggest a capacitor (C2) with a capacity of 0.25 F. Below an overview and the schematics of a charging circuitry is shown:



This circuit is designed for an energy storage capacitor specified for 3.3 V (e.g. PAS614L-VL3. Please pay great attention to manufacturers handling and soldering procedures!)





#### Charge switcher

The charge switcher connects both short term storage and long term storage parallel to the energy source as soon as the STM 300 supply voltage reaches the typical VON threshold of 2.45 V. Supposing VDD then falls below VON, the energy source will be switched back to short term storage alone, for faster recharging. As long as the voltage on long term storage remains below VON, the charge switcher will continuously switch the energy source between short term and long term storage, trying to ensure continuous device operation. That is because of the higher resistance and capacitance of long term storage, which would lead to much too long charging (i.e. non-operative time). In addition short term storage cannot be charged over this threshold until the voltage on long term storage exceeds VON. Charge switcher is the PMOS transistor Q1, driven from the STM 300 charge control output CCO over T1A. To start with, as long as the STM 300 VDD voltage is below the VON threshold, only the small storage (C1) is filled over D3. Once the threshold is reached, the CCO control signal goes High, T1B and Q2 are turned on and the long term storage (C2) will be filled over Q2.

#### **Overvoltage protection**

All of these long term storage solutions have a rated operating voltage that must be not exceeded. After reaching this limit the energy source is automatically separated from storage to avoid any damage. Overvoltage protection is implemented by the S-1000C32-M5T1x voltage detector from Seiko (SII) or the NCP300LSN30T1G series (ON Semiconductor), which limits the maximum charging voltage to 3.3 V to avoid damaging long term energy storage. In case a different voltage limit is required, this device has to be replaced by a suitable voltage variant. As soon as the voltage on D2 anode or the voltage detector input exceeds the selected threshold, the voltage detector delivers a High level on its output connected to the T1A emitter. The T1A base is consequently lower polarized than its emitter and the transistor is turned off. That means Q1 is turned off too — the energy source is switched off and long term storage is protected.

The selected voltage detector must have a very low quiescent current in the operating range, and an appropriate threshold voltage, corresponding to the selected long term energy storage voltage (e.g. threshold nominally 3.2 V for a 3.3 V capacitor). If the selected threshold is too low, e.g. 3.0 V, a relatively high amount of energy corresponding to a useful voltage difference of 0.3 V would be wasted. If the nominal threshold is too high, e.g. exactly 3.3 V (not forgetting that this could reach 3.4 V as a result of additional manufacturer tolerances), it could be critical for energy storage life expectation. The S-1000C32-M5T1x voltage detector consequently looks like the best compromise here (rated 3.2 V)

#### Undervoltage protection

PAS capacitors should not be deep discharged to voltages below 1.5V. To avoid long term degradation of their capacity and lifetime, an undervoltage protection block is added. Undervoltage protection is also implemented through Q2. In normal operation, when VDD reaches the VON threshold, the STM 300 charge control CCO goes high, T1B rapidly discharges C3 to GND and Q2 turns on long term storage. The C3 charge recovers very slowly over R6, so Q2 cannot turn off long term storage immediately. Only if VDD falls below VOFF for a longer time does C3 have time to recover and finally to turn off Q2 and thus the long term storage path (over D4) from the STM 300, avoiding deep discharge.

For more details and alternative circuits please refer to application note <u>AN208</u>.

## 3.2 Using the SCO pin

STM 300 provides an output signal at SCO which is suited to control the supply of the sensor circuitry. This helps saving energy as the sensor circuitry is only powered as long as necessary. In the default configuration SCO provides a HIGH signal 2 ms (delay time) before the analog inputs are read. Via the programming interface (see 2.8.2) it is possible to adjust the delay time and also the polarity of the signal.



The figure above shows, how the SCO pin (with default polarity) can be used to control an external sensor circuit.



Do not supply sensors directly from SCO as this output can only provide maximum 15  $\mu A!$ 

## 3.3 Using the WAKE pins

The logic input circuits of the WAKE0 and WAKE1 pins are supplied by UVDD and therefore also usable in "Deep Sleep Mode" or "Flywheel Sleep Mode" (via API only). Due to current minimization there is no internal pull-up or pull-down at the WAKE pins.

When STM 300 is in "Deep Sleep Mode" or "Flywheel Sleep Mode" (via API only) and the logic levels of WAKE0 and / or WAKE1 is changed, STM 300 starts up.



As the there is no internal pull-up or pull-down at the WAKE pins, it has to be ensured by external circuitry, that the WAKE pins are at a defined logic level at any time.



When using the UVDD regulator output as source for the logic HIGH of the WAKE pins, it is strongly recommended to protect the ultra low power UVDD voltage regulator against (accidental) excessive loading by connection of an external 1.8 M $\Omega$  series resistor.





The figure above shows two examples how the WAKE inputs may be used. When the LRN button is pressed WAKE1 is pulled to GND and a teach-in telegram is transmitted. As long as the button is pressed a small current is flowing from UVDD to GND. WAKE0 is connected to a toggle switch. There is no continuous flow of current in either position of the switch.

If more digital inputs with WAKE functionality are needed in an application, WAKE0 can be combined with some of the digital inputs as shown below:



#### 3.4 Using RVDD

If RVDD is used in an application circuit a serial ferrite bead shall be used and wire length should be as short as possible (<3 cm). The following ferrite beads have been tested: 74279266 (0603), 74279205 (0805) from Würth Elektronik. During radio transmission and reception only small currents may be drawn (I<100  $\mu$ A).

Pulsed current drawn from RVDD has to be avoided. If pulsed currents are necessary, sufficient blocking has to be provided.

## 3.5 Antenna options

#### 3.5.1 Overview

Several antenna types have been investigated by EnOcean. They all have advantages and disadvantages as shown in the following table.

Advantages	Disadvantages
Whip Antenna (15 cm @ 315 MHz, 8.5 cn	n @ 868 MHz)
Cheap	Automatic placement difficult
Omnidirectional	Bending influences performance
	Large size
Chip Antenna (AMD1103-ST01 @ 315 MF	Iz/868 MHz)
Omnidirectional	Expensive
Small size	Very sensitive to environment (GND plane, components), minimum distance
	space to other components needed
Automatic placement possible	
Splatch Antenna (ANT-315-SP1 @ 315 M	Hz, ANT-868-SP1 @ 868 MHz)
Omnidirectional	Expensive
Not very sensitive to environment, low dis-	Large size
tance space to other components required	
Automatic placement possible	
Helical Antenna (ANT-315-HE @ 315 MHz	z)
Omnidirectional	Large distance space to other compo-
	nents required
Cheap	Large size (3D)

868 MHz modules used in Europe do not need additional approval if the external antenna fulfils the following requirements:

Antenna type	Passive	Mandatory for radio approval
Frequency band	868 MHz ISM	Antenna must be suited for this band
Impedance	~50 Ohm	Mandatory for radio approval
Maximum gain	≤ 0 dBi	Mandatory for radio approval
VSWR	≤ 1.5:1	Important for compatibility with EnOcean protocol
Return Loss	> 14 dB	Important for compatibility with EnOcean protocol
Bandwidth	≤ 20 MHz	Important if 10 V/m EMI robustness required for device



For 315 MHz modules (STM 300C and TCM 3X0C) please note that a full approval is needed if modules are used with antennas other than the specified whip antenna.



# 3.5.2 Whip antenna 315 MHz

Antenna: 150 mm wire, connect to RF\_WHIP

Minimum GND plane: 50 mm x 50 mm Minimum distance space: 10 mm

#### 868 MHz

Antenna: 86 mm wire, connect to RF\_WHIP

Minimum GND plane: 38 mm x 18 mm Minimum distance space: 10 mm



#### Specification of the whip antenna; L=150 mm @ 315 MHz, L=86 mm @ 868 MHz



#### 3.5.3 Chip antenna

#### 315 MHz

Antenna: AMD1103-ST01 Manufacturer: Mitsubishi Matching circuit:



L1=47 nH L2=390 nH

```
L3 optional for additional optimization
```

#### Minimum distance space and layout:



Minimum distance space above and below PCB: 11 mm



#### 868 MHz

Antenna: AMD1103-ST01 Manufacturer: Mitsubishi Matching circuit:



Minimum distance space, PCB properties and layout:

PCB Material: FR4,  $t_{Cu}$ =35 µm,  $h_{PCB}$ =1.5 mm, RF\_50 micro strip width = 2.7 mm, if these parameters can not be hold, then new matching values are required.



Minimum distance space above and below PCB: 11 mm



#### 3.5.4 Splatch antenna

#### 315/868 MHz

Antenna: ANT-315-SP Manufacturer: Linx Technologies / Antenna Factor Matching circuit: Not needed Minimum distance space, PCB properties and layout: PCB Material: FR4,  $t_{Cu}$ =35 µm,  $h_{PCB}$ =1.5 mm, RF\_50 micro strip width = 2.7 mm if these parameters can not be hold, then additional matching is required see chapter 3.5.3.



Minimum distance space above and below PCB: 12 mm



#### 3.5.5 Helical antenna

#### 315 MHz

Antenna: ANT-315-HE Manufacturer: Linx Technologies / Antenna Factor Matching circuit:



Minimum distance space and layout:



Minimum distance above and below axis of antenna: 21 mm



## 3.6 Layout recommendations for foot pattern



The length of lines connected to I/Os should not exceed 5 cm.



It is recommended to have a complete GND layer, at least below the module and directly connected components. GND must be however avoided 0...0.3mm below the PCB in the area marked by the circle in the figures below.



The RVDD line should be kept as short as possible. Please consider recommendations in section 3.4.



Top layer



Solder resist top layer







#### Solder paste top layer



The data above is also available as EAGLE library.

In order to ensure good solder quality a solder mask thickness of 150  $\mu$ m is recommended.

In case a 120  $\mu$ m solder mask is used, it is recommended to enlarge the solder print. The pads on the solder print should then be 0.1 mm larger than the pad dimensions of the module as specified in chapter 1.3. (not relative to the above drawing).

Nevertheless an application and production specific test regarding the amount of soldering paste should be performed to find optimum parameters.



## 3.7 Soldering information

STM 300 has to be soldered according to IPC/JEDEC J-STD-020C standard.

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	3° C/second max.
<b>Preheat</b> – Temperature Min (Ts <sub>min</sub> ) – Temperature Max (Ts <sub>max</sub> ) – Time (ts <sub>min</sub> to ts <sub>max</sub> )	150 °C 200 °C 60-180 seconds
Time maintained above: – Temperature $(T_L)$ – Time $(t_L)$	217 °C 60-150 seconds
Peak/Classification Temperature (Tp)	260 °C
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.



STM 300 shall be handled according to Moisture Sensitivity Level MSL4 which means a floor time of 72 h. STM 300 may be soldered only once, since one time is already consumed at production of the module itself.

Once the dry pack bag is opened, the desired quantity of units should be removed and the bag resealed within two hours. If the bag is left open longer than 30 minutes the desiccant should be replaced with dry desiccant. If devices have exceeded the specified floor life time of 72 h, they may be baked according IPC/JEDEC J-STD-033B at max. 90°C for less than 60 h.

Devices packaged in moisture-proof packaging should be stored in ambient conditions not exceeding temperatures of 40 °C or humidity levels of 90% r.h.

STM 300 modules have to be soldered within 6 months after delivery!



## 3.8 Tape & Reel specification





## 3.9 Transmission range

The main factors that influence the system transmission range are type and location of the antennas of the receiver and the transmitter, type of terrain and degree of obstruction of the link path, sources of interference affecting the receiver, and "Dead" spots caused by signal reflections from nearby conductive objects. Since the expected transmission range strongly depends on this system conditions, range tests should categorically be performed before notification of a particular range that will be attainable by a certain application.

The following figures for expected transmission range are considered by using a PTM, a STM or a TCM radio transmitter device and the TCM radio receiver device with preinstalled whip antenna and may be used as a rough guide only:

- Line-of-sight connections: Typically 30 m range in corridors, up to 100 m in halls
- Plasterboard walls / dry wood: Typically 30 m range, through max. 5 walls
- Line-of-sight connections: Typically 30 m range in corridors, up to 100 m in halls
- Ferroconcrete walls / ceilings: Typically 10 m range, through max. 1 ceiling
- Fire-safety walls, elevator shafts, staircases and supply areas should be considered as screening.

The angle at which the transmitted signal hits the wall is very important. The effective wall thickness – and with it the signal attenuation – varies according to this angle. Signals should be transmitted as directly as possible through the wall. Wall niches should be avoided. Other factors restricting transmission range:

- Switch mounted on metal surfaces (up to 30% loss of transmission range)
- Hollow lightweight walls filled with insulating wool on metal foil
- False ceilings with panels of metal or carbon fiber
- Lead glass or glass with metal coating, steel furniture

The distance between EnOcean receivers and other transmitting devices such as computers, audio and video equipment that also emit high-frequency signals should be at least 0.5 m

A summarized application note to determine the transmission range within buildings is available as download from <u>www.enocean.com</u>.



## 4 AGENCY CERTIFICATIONS

The modules have been tested to fulfil the approval requirements for CE (STM 300) and FCC/IC (STM 300C) based on the built-in firmware.



When developing customer specific firmware based on the API for this module, special care must be taken not to exceed the specified regulatory limits, e.g. the duty cycle limitations!

## 4.1 CE Approval

The STM 300 module bears the EC conformity marking CE and conforms to the R&TTE EUdirective on radio equipment. The assembly conforms to the European and national requirements of electromagnetic compatibility. The conformity has been proven and the according documentation has been deposited at EnOcean. The modules can be operated without notification and free of charge in the area of the European Union and in Switzerland.



- EnOcean RF modules must not be modified or used outside their specification limits.
- EnOcean RF modules may only be used to transfer digital or digitized data. Analog speech and/or music are not permitted.
- EnOcean RF modules must not be used with gain antennas, since this may result in allowed ERP or spurious emission levels being exceeded.
- The final product incorporating EnOcean RF modules must itself meet the essential requirement of the R&TTE Directive and a CE marking must be affixed on the final product and on the sales packaging each. Operating instructions containing a Declaration of Conformity has to be attached.
- If the STM 300 transmitter is used according to the regulations of the 868.3 MHz band, a so-called "Duty Cycle" of 1% per hour must not be exceeded. Permanent transmitters such as radio earphones are not allowed.
- The module must be used with only the following approved antenna(s).

Туре	Parameter	Value		
Wire/Monopole at RF_WHIP	Maximum gain	1.0 dBi		
External antenna at RF_50	Antenna type	Passive		
	Impedance	~50 Ohm		
	Maximum gain	≤ 0 dBi		



## 4.2 FCC (United States) certification STM 300C LIMITED MODULAR APPROVAL

This is an RF module approved for Limited Modular use operating as an intentional transmitting device with respect to 47 CFR 15.231(a-c) and is limited to OEM installation. The module is optimized to operate using small amounts of harvested energy, such as can be collected by a small solar cell exposed to ambient light. The module transmits short radio packets comprised of control signals, (in some cases the control signal may be accompanied with data) such as those used with alarm systems, door openers, remote switches, and the like. The module does not support continuous streaming of voice, video, or any other forms of streaming data; it sends only short packets containing control signals and possibly data and is typically powered by a solar cell in ambient light. The module is designed to comply with, has been tested according to 15.231(a-c), and has been found to comply with each requirement. Thus, a finished device containing the STM 300C radio module can be operated in the United States without additional Part 15 FCC approval (approval(s) for unintentional radiators may be required for the OEM's finished product), under EnOcean's FCC ID number. This greatly simplifies and shortens the design cycle and development costs for OEM integrators.

The module can be triggered manually or automatically, which cases are described below.

#### **Manual Activation**

The radio module can be configured to transmit a short packetized control signal if triggered manually. The module can be triggered, by pressing a switch, for example. The packet contains one (or more) control signals that is(are) intended to control something at the receiving end. The packet may also contain data. Depending on how much energy is available from the energy source, subsequent manual triggers can initiate the transmission of additional control signals. This may be necessary if prior packet(s) was (were) lost to fading or interference. Subsequent triggers can also be initiated as a precaution if any doubt exists that the first packet didn't arrive at the receiver. Each packet that is transmitted, regardless of whether it was the first one or a subsequent one, will only be transmitted if enough energy is available from the energy source.

#### **Automatic Activation**

The radio module also can be configured to transmit a short packetized control signal if triggered automatically, by a relevant change of its inputs, for example. Again, the packet contains a control signal that is intended to control something at the receiving end and may also contain data. As above, it is possible for the packet to get lost and never reach the receiver. However, if enough energy is available from the energy source, and the module has been configured to do so, then another packet or packets containing the control signal may be transmitted at a later, unpredictable time.

The device is capable to operate as a repeater, which can receive signals from the following list of FCC/IC approved transmitters, and retransmit the signals.

PTM 200C	FCC ID:SZV-PTM200C	IC:5713A-PTM200C
STM 110C	FCC ID:SZV-STM110C	IC:5713A-STM110C
TCM 200C	FCC ID:SZV-TCM2XXC	IC:5713A-TCM2XXC
TCM 220C	FCC ID:SZV-TCM2XXC	IC:5713A-TCM2XXC
TCM 300C	FCC ID:SZV-STM300C	IC:5713A-STM300C
STM 300C	FCC ID:SZV-STM300C	IC:5713A-STM300C
TCM 320C	FCC ID:SZV-TCM320C	IC:5713A-TCM320C



#### **OEM Requirements**

In order to use EnOcean's FCC ID number, the OEM must ensure that the following conditions are met.

- End users of products, which contain the module, must not have the ability to alter the firmware that governs the operation of the module. The agency grant is valid only when the module is incorporated into a final product by OEM integrators.
- The end-user must not be provided with instructions to remove, adjust or install the module.
- The Original Equipment Manufacturer (OEM) must ensure that FCC labeling requirements are met. This includes a clearly visible label on the outside of the final product. Attaching a label to a removable portion of the final product, such as a battery cover, is not permitted. The label must include the following text:

Contains FCC ID: SZV-STM300C The enclosed device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (i.) this device may not cause harmful interference and (ii.) this device must accept any interference received, including interference that may cause undesired operation.

When the device is so small or for such use that it is not practicable to place the statement above on it, the information required by this paragraph shall be placed in a prominent location in the instruction manual or pamphlet supplied to the user or, alternatively, shall be placed on the container in which the device is marketed. However, the FCC identifier or the unique identifier, as appropriate, must be displayed on the device.

The user manual for the end product must also contain the text given above.

- Changes or modifications not expressly approved by EnOcean could void the user's authority to operate the equipment.
- The OEM must ensure that timing requirements according to 47 CFR 15.231(a-c) are met.
- The OEM must sign the OEM Limited Modular Approval Agreement with EnOcean
- The module must be used with only the following approved antenna(s).

Part Numbe	r Type	Gain
N.A.	Wire/Monopole	1.0 dBi



**TCB** 

STM 300 / STM 300C

## тсв

GRANT OF EQUIPMENT AUTHORIZATION Certification Issued Under the Authority of the Federal Communications Commission

By:

PHOENIX TESTLAB GmbH Koenigswinkel 10 D-32825 Blomberg, Germany

Date of Grant: 04/07/2010 Application Dated: 04/07/2010

EnOcean GmbH Kolpingring 18a Oberhaching, 82041 Germany

Attention: Armin Anders , Director Product Marketing

#### NOT TRANSFERABLE

EQUIPMENT AUTHORIZATION is hereby issued to the named GRANTEE, and is VALID ONLY for the equipment identified hereon for use under the Commission's Rules and Regulations listed below.





## 4.3 IC (Industry Canada) certification

In order to use EnOcean's IC number, the OEM must ensure that the following conditions are met:

Labeling requirements for Industry Canada are similar to those required by the FCC. The Original Equipment Manufacturer (OEM) must ensure that IC labeling requirements are met. A clearly visible label on the outside of a non-removable part of the final product must include the following text:

Contains IC: 5713A-STM300C

• The OEM must sign the OEM Limited Modular Approval Agreement with EnOcean

						TESTLAB	
TECHNICAL APPROVAL CERTIFICATE			CERTIFICAT D'APPROBATION TECHNIQUE				
based on the A between the E	based on the Agreement on Mutual Recognition between the European Community and Canada			en se basant l'accord de reconnaissance mutuelle entre la Communauté Européenne et le Canada			
CERTIFICATE NUM NUMÉRO DE CERTIFICA				10-110676			
CERTIFICATION NU NUMÉRO DE CERTIFICA				IC: 5713A-STM300C			
TYPE OF SERVICE					MILY CERTIFICATION / MODULAR APPROVAL		
CERTIFICATE HOLD				EnOcean GmbH Kolpingring 18a 82041 Oberhaching Germany			
TYPE OF EQUIPME GENRE DE MATÉRIEL	NT			Transceiver I	Module		
TRADE NAME AND MARQUE ET NUMÉRO D		UMBER		EnOcean		TCM300C / STM300C	
FREQUENCY RANG BANDE DE FRÉQUENCE				315MHz			
EMISSION DESIGNA DÉSIGNATION D'ÉMISSI				373KA1D			
R.F. POWER RATIN PUISSANCE NOMINALE				1			
ANTENNA INFORMA				Wire Antenna	a 15cm		
CONTACT INFORMATION OF TESTING LABORATORY COORDONNÉES DU LABORATOIRE D'ESSAI		Pkm electronic GmbH Ohmstrasse 1 84160 Frontenhausen Germany					
CERTIFIED TO SPECIFICATION / ISSUE CERTIFIÉ SELON LE CAHIER DES CHARGES / ÉDITION		RSS-210 Issue 7, RSS-GEN Issue 2 RSS-102 Issue 4					
equipment, are acted on acco	rdingly by the is	ssuing office and will depe	ind on the exis	ting radio environme	nt, service and I	nse applications, where applicable to use certified ocation of operation. This certificate is issued on and procedures issued by the Department.	
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Certification Body (	Code: DEC	0003 re	cognised Bundesnetzagen		igned by /	Signataire Uwe Dollitz	
Blomberg, 07 April	2010			F	oreign Cei	rtification Body (FCB)	
		8	NetzA-CAB-04/22	-53			
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